

## Rail-to-rail 1.1 V nanopower comparator

Datasheet –production data

### Features

- Ultra low current consumption: 210 nA typ.
- Propagation delay: 2  $\mu$ s typ.
- Rail-to-rail inputs
- Push-pull output
- Supply operation from 1.1 V to 5.5 V
- Wide temperature range: -40 to +125 °C
- ESD tolerance: 4 kV HBM / 300 V MM
- SMD package

### Applications

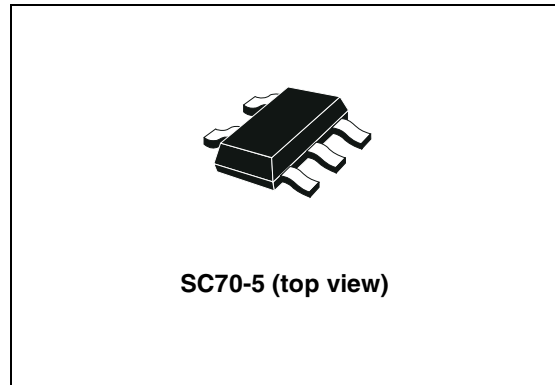
- Portable systems
- Signal conditioning
- Medical

### Description

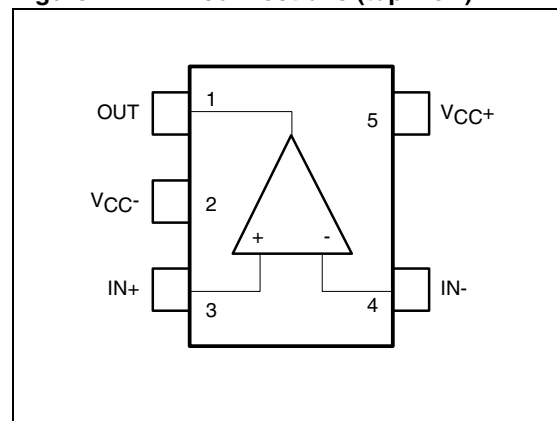
The TS881 device is a single comparator featuring ultra low supply current (210 nA typical with output high,  $V_{CC} = 1.2$  V, no load) with rail-to-rail input and output capability. The performance of this comparator allows it to be used in a wide range of portable applications. The TS881 device minimizes battery supply leakage and therefore enhances battery lifetime.

Operating from 1.1 to 5.5 V supply voltage, this comparator can be used over a wide temperature range (-40 to +125 °C) keeping the current consumption at an ultra low level.

The TS881 device is available in the SC70-5 package, allowing great space saving on the PCB.



**Figure 1. Pin connections (top view)**



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# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage <sup>(1)</sup>	6	V
$V_{ID}$	Differential input voltage <sup>(2)</sup>	±6	V
$V_{IN}$	Input voltage range	$(V_{CC-}) - 0.3$ to $(V_{CC+}) + 0.3$	V
$R_{THJA}$	Thermal resistance junction-to-ambient <sup>(3)</sup> SC70-5	205	°C/W
$T_{STG}$	Storage temperature	-65 to +150	°C
$T_J$	Junction temperature	150	°C
$T_{LEAD}$	Lead temperature (soldering 10 seconds)	260	°C
ESD	Human body model (HBM) <sup>(4)</sup>	4	kV
	Machine model (MM) <sup>(5)</sup>	300	V
	Charged device model (CDM) <sup>(6)</sup>	1300	
	Latch-up immunity	200	mA

1. All voltage values, except differential voltages, are referenced to  $V_{CC-}$ .  $V_{CC}$  is defined as the difference between  $V_{CC+}$  and  $V_{CC-}$ .
2. The magnitude of input and output voltages must never exceed the supply rail  $\pm 0.3$  V.
3. Short-circuits can cause excessive heating. These values are typical.
4. According to JEDEC standard JESD22-A114F.
5. According to JEDEC standard JESD22-A115A.
6. According to ANSI/ESD STM5.3.1.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$T_{oper}$	Operating temperature range	-40 to +125	°C
$V_{CC}$	Supply voltage $-40\text{ °C} < T_{amb} < +125\text{ °C}$	1.1 to 5.5	V
$V_{ICM}$	Common mode input voltage range $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$	$V_{CC-} - 0.2$ to $V_{CC+} + 0.2$ $V_{CC-}$ to $V_{CC+} + 0.2$	V

## 2 Electrical characteristics

**Table 3.**  $V_{CC} = +1.2\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup>

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage <sup>(2)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$	-6	1	6	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40\text{ °C} < T_{amb} < +125\text{ °C}$		3		$\mu\text{V}/\text{°C}$
$V_{HYST}$	Input hysteresis voltage <sup>(3)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$	1.6	2.4	4.2	mV
$I_{IO}$	Input offset current <sup>(4)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$			10 100	pA
$I_{IB}$	Input bias current <sup>(4)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$		1	10 100	pA
$I_{CC}$	Supply current per operator	No load, output low, $V_{ID} = -0.1\text{ V}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$ No load, output high, $V_{ID} = +0.1\text{ V}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$		300 210	450 500 1050 350 400 950	nA
$I_{SC}$	Short-circuit current	Source Sink		1.4 1.0		mA
$V_{OH}$	Output voltage high	$I_{source} = 0.2\text{ mA}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$	1.13 1.10 1.00	1.15		V
$V_{OL}$	Output voltage low	$I_{sink} = 0.2\text{ mA}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$		40	50 60 70	mV
CMRR	Common mode rejection ratio	$0 < V_{ICM} < V_{CC}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$	50	68		dB
$T_{PLH}$	Propagation delay (low to high)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$ Overdrive = 100 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$		6 2.2	11 13 3.1 3.4	$\mu\text{s}$
$T_{PHL}$	Propagation delay (high to low)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$ Overdrive = 100 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$		5.1 2.0	8 10 2.6 3.1	$\mu\text{s}$
$T_R$	Rise time (10% to 90%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		100		ns

**Table 3.**  $V_{CC} = +1.2\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup> (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$T_F$	Fall time (90% to 10%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		110		ns
$T_{ON}$	Power-up time			1.0	1.5	ms

1. All values over the temperature range are guaranteed through correlation and simulation. No production test is performed at the temperature range limits.
2. The offset is defined as the average value of positive and negative trip points (input voltage differences requested to change the output state in each direction).
3. The hysteresis is a built-in feature of the TS881 device. It is defined as the voltage difference between the trip points.
4. Maximum values include unavoidable inaccuracies of the industrial tests.

**Table 4.**  $V_{CC} = +2.7\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup>

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage <sup>(2)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$	-6	1	6	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40\text{ °C} < T_{amb} < +125\text{ °C}$		3		$\mu\text{V}/\text{°C}$
$V_{HYST}$	Input hysteresis voltage <sup>(3)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$	1.6	2.7	4.2	mV
$I_{IO}$	Input offset current <sup>(4)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$			10 100	pA
$I_{IB}$	Input bias current <sup>(4)</sup>	$-40\text{ °C} < T_{amb} < +125\text{ °C}$		1	10 100	pA
$I_{CC}$	Supply current per operator	No load, output low, $V_{ID} = -0.1\text{ V}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$  No load, output high, $V_{ID} = +0.1\text{ V}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$		310  220	450 500 1150  350 400 1050	nA
$I_{SC}$	Short-circuit current	Source Sink		12 10		mA
$V_{OH}$	Output voltage high	$I_{source} = 2\text{ mA}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$	2.48 2.40 2.10	2.51		V
$V_{OL}$	Output voltage low	$I_{sink} = 2\text{ mA}$ $-40\text{ °C} < T_{amb} < +85\text{ °C}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$		140	210 230 310	mV
CMRR	Common mode rejection ratio	$0 < V_{ICM} < V_{CC}$ $-40\text{ °C} < T_{amb} < +125\text{ °C}$	55	74		dB
$T_{PLH}$	Propagation delay (low to high)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$  Overdrive = 100 mV $-40\text{ °C} < T_{amb} < +125\text{ °C}$		6.3  2.4	12 13 3.0 3.7	$\mu\text{s}$

**Table 4.**  $V_{CC} = +2.7\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup> (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$T_{PHL}$	Propagation delay (high to low)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$  Overdrive = 100 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		6.4  2.3	12 14  3.0 3.7	$\mu\text{s}$
$T_R$	Rise time (10% to 90%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		120		ns
$T_F$	Fall time (90% to 10%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		130		ns
$T_{ON}$	Power-up time			0.9	1.5	ms

1. All values over the temperature range are guaranteed through correlation and simulation. No production test is performed at the temperature range limits.
2. The offset is defined as the average value of positive and negative trip points (input voltage differences requested to change the output state in each direction).
3. The hysteresis is a built-in feature of the TS881. It is defined as the voltage difference between the trip points.
4. Maximum values include unavoidable inaccuracies of the industrial tests.

**Table 5.**  $V_{CC} = +5\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup>

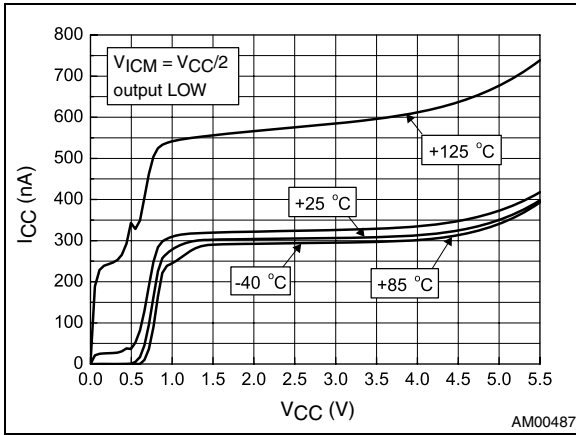
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{IO}$	Input offset voltage <sup>(2)</sup>	$-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$	-6	1	6	mV
$\Delta V_{IO}$	Input offset voltage drift	$-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		3		$\mu\text{V}/^{\circ}\text{C}$
$V_{HYST}$	Input hysteresis voltage <sup>(3)</sup>	$-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$	1.6	3.1	4.2	mV
$I_{IO}$	Input offset current <sup>(4)</sup>	$-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$			10 100	pA
$I_{IB}$	Input bias current <sup>(4)</sup>	$-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		1	10 100	pA
$I_{CC}$	Supply current per operator	No load, output low, $V_{ID} = -0.1\text{ V}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +85\text{ }^{\circ}\text{C}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$  No load, output high, $V_{ID} = +0.1\text{ V}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +85\text{ }^{\circ}\text{C}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		350  250	500 750 1350  400 650 1250	nA
$I_{SC}$	Short-circuit current	Source Sink		32 36		mA
$V_{OH}$	Output voltage high	$I_{source} = 2\text{ mA}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +85\text{ }^{\circ}\text{C}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$	4.86 4.75 4.60	4.90		V
$V_{OL}$	Output voltage low	$I_{sink} = 2\text{ mA}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +85\text{ }^{\circ}\text{C}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		95	130 170 280	mV

Table 5.  $V_{CC} = +5\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ ,  $V_{ICM} = V_{CC}/2$  (unless otherwise specified)<sup>(1)</sup> (continued)

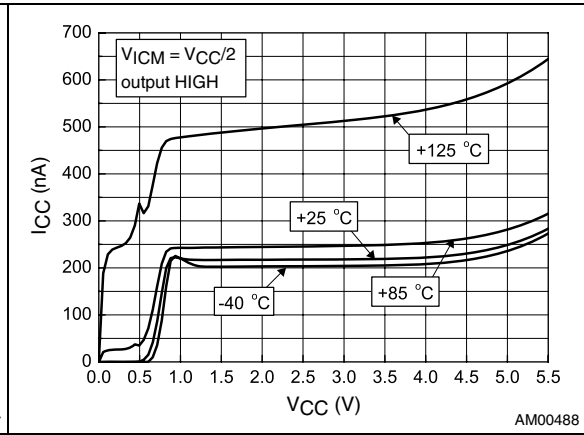
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
CMRR	Common mode rejection ratio	$0 < V_{ICM} < V_{CC}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$	55	78		dB
SVR	Supply voltage rejection	$\Delta V_{CC} = 1.2\text{ V to } 5\text{ V}$ $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$	65	80		dB
$T_{PLH}$	Propagation delay (low to high)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$  Overdrive = 100 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		7.8  2.6	13 22 3.4 4.1	$\mu\text{s}$
$T_{PHL}$	Propagation delay (high to low)	$f = 1\text{ kHz}$ , $C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$ Overdrive = 10 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$  Overdrive = 100 mV $-40\text{ }^{\circ}\text{C} < T_{amb} < +125\text{ }^{\circ}\text{C}$		8.9  2.7	16 19 3.5 4.2	$\mu\text{s}$
$T_R$	Rise time (10% to 90%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		160		ns
$T_F$	Fall time (90% to 10%)	$C_L = 30\text{ pF}$ , $R_L = 1\text{ M}\Omega$		150		ns
$T_{ON}$	Power-up time			1.1	1.5	ms

1. All values over the temperature range are guaranteed through correlation and simulation. No production test is performed at the temperature range limits.
2. The offset is defined as the average value of positive and negative trip points (input voltage differences requested to change the output state in each direction).
3. The hysteresis is a built-in feature of the TS881 device. It is defined as the voltage difference between the trip points.
4. Maximum values include unavoidable inaccuracies of the industrial tests.

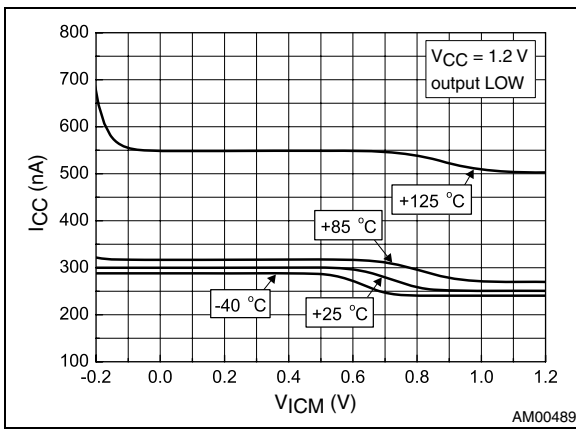
**Figure 2. Current consumption vs. supply voltage - output low**



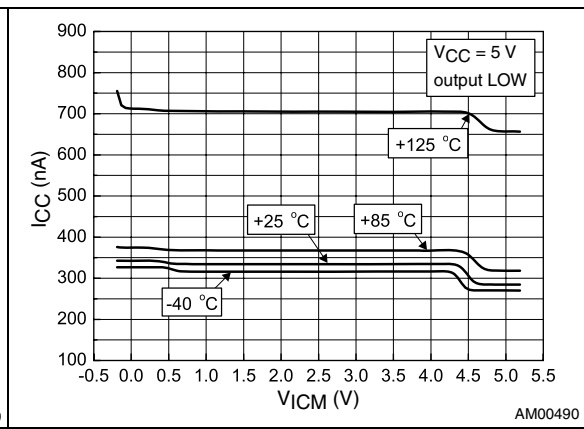
**Figure 3. Current consumption vs. supply voltage - output high**



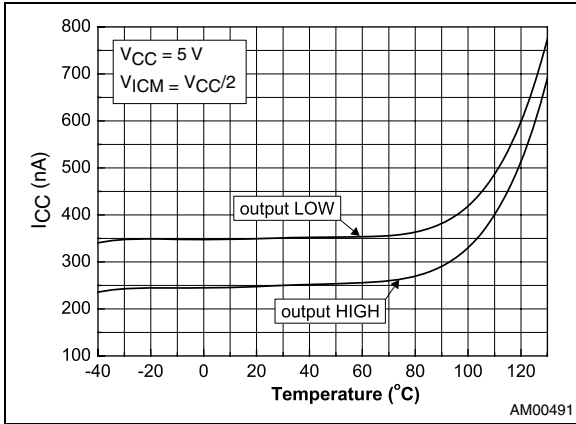
**Figure 4. Current consumption vs. input common mode voltage at V<sub>CC</sub> = 1.2 V**



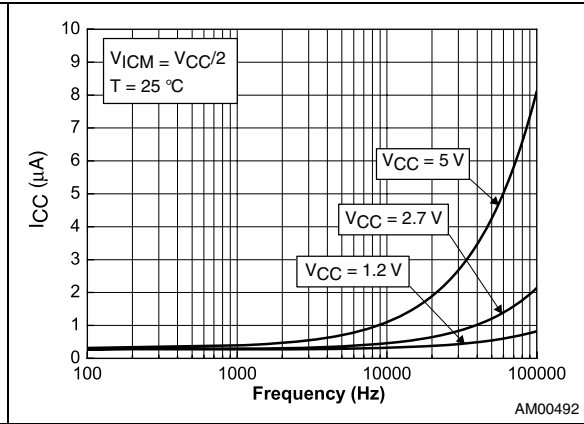
**Figure 5. Current consumption vs. input common mode voltage at V<sub>CC</sub> = 5 V**



**Figure 6. Current consumption vs. temperature**

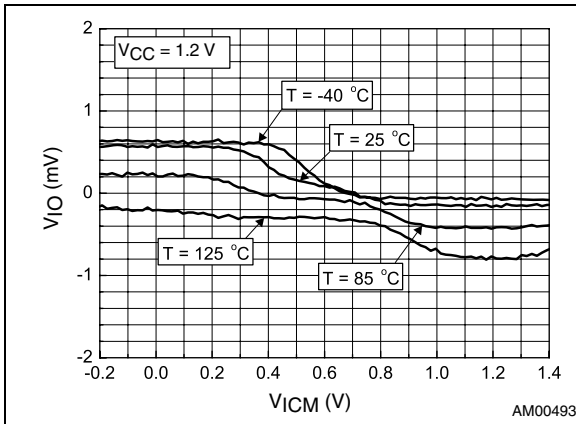


**Figure 7. Current consumption vs. toggle frequency**

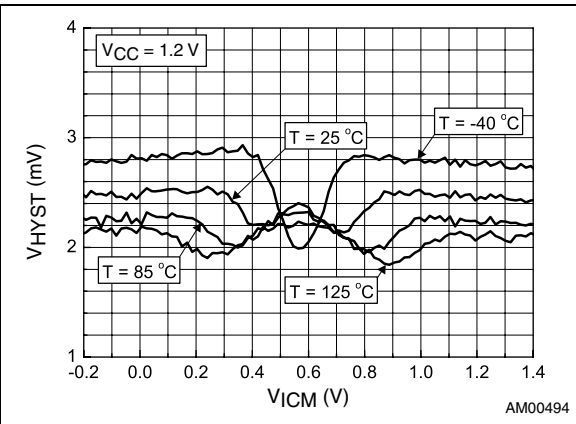




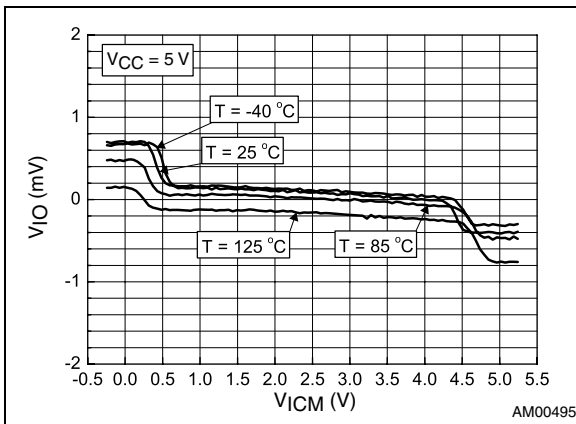
**Figure 8. Input offset voltage vs. input common mode voltage at  $V_{CC} = 1.2\text{ V}$**



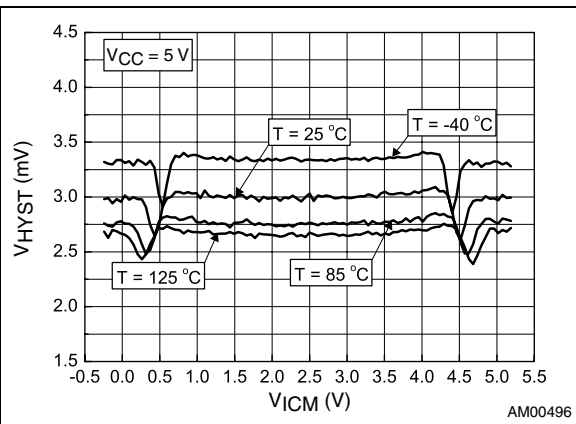
**Figure 9. Input hysteresis voltage vs. input common mode voltage at  $V_{CC} = 1.2\text{ V}$**



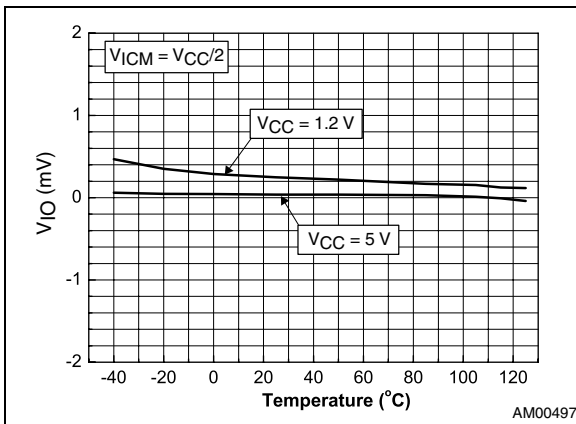
**Figure 10. Input offset voltage vs. input common mode voltage at  $V_{CC} = 5\text{ V}$**



**Figure 11. Input hysteresis voltage vs. input common mode voltage at  $V_{CC} = 5\text{ V}$**



**Figure 12. Input offset voltage vs. temperature**



**Figure 13. Input hysteresis voltage vs. temperature**

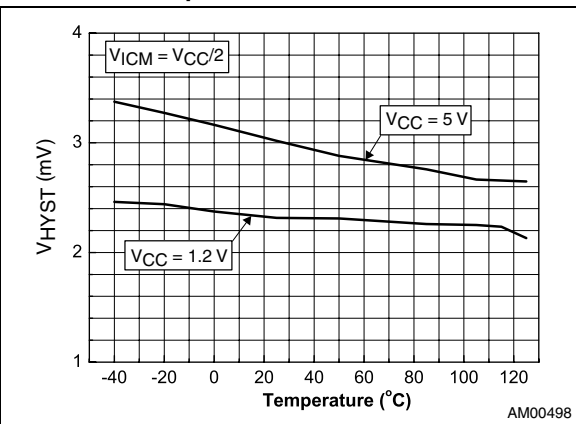


Figure 14. Output voltage drop vs. sink current at  $V_{CC} = 1.2\text{ V}$  Figure 15. Output voltage drop vs. source current at  $V_{CC} = 1.2\text{ V}$

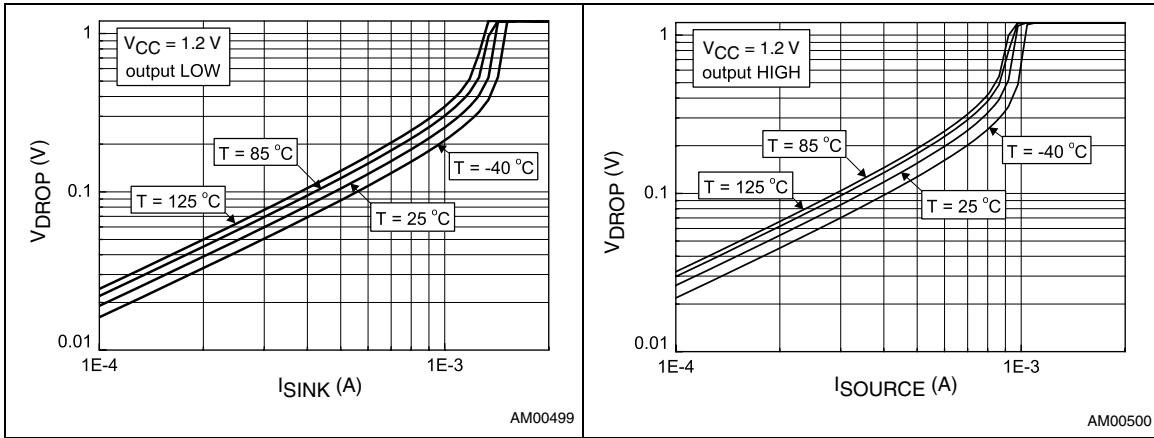


Figure 16. Output voltage drop vs. sink current at  $V_{CC} = 2.7\text{ V}$  Figure 17. Output voltage drop vs. source current at  $V_{CC} = 2.7\text{ V}$

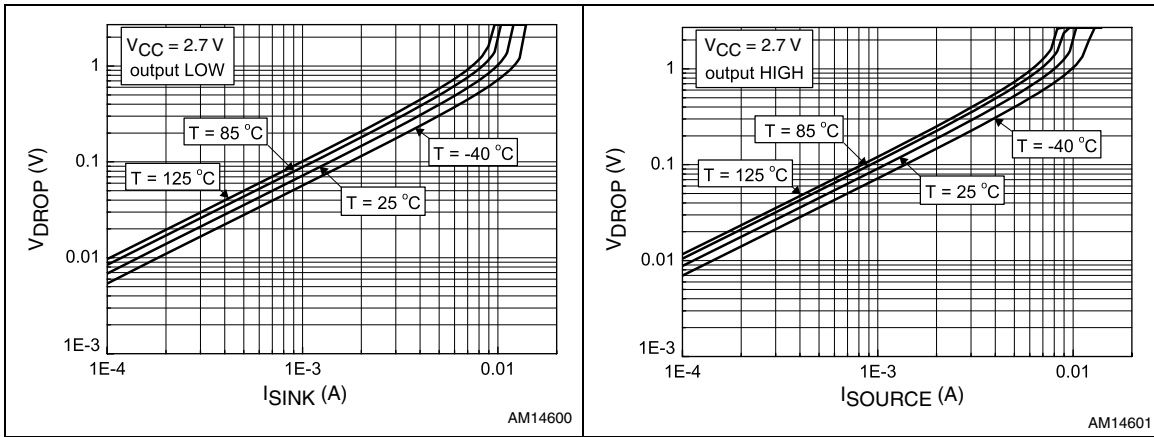


Figure 18. Output voltage drop vs. sink current at  $V_{CC} = 5\text{ V}$  Figure 19. Output voltage drop vs. source current at  $V_{CC} = 5\text{ V}$

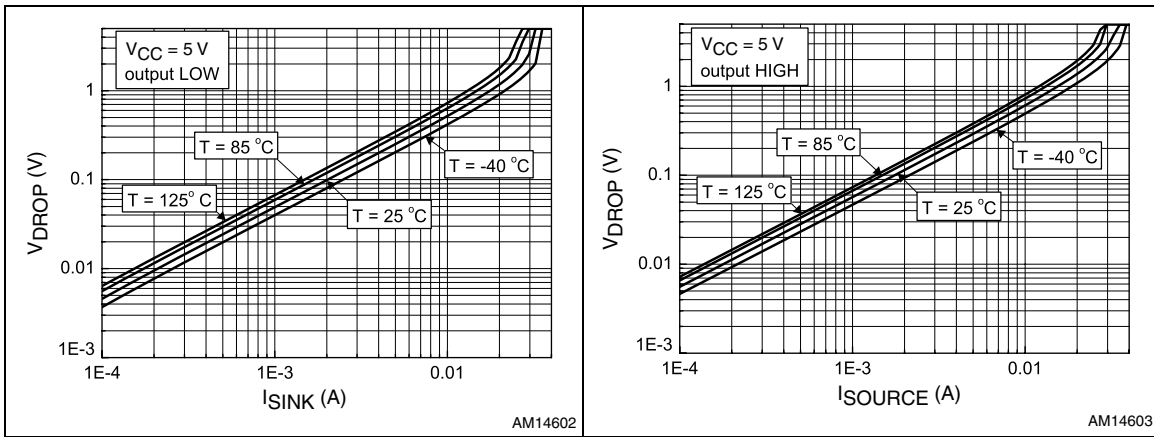


Figure 20. Propagation delay  $T_{PLH}$  vs. input common mode voltage at  $V_{CC} = 1.2\text{ V}$

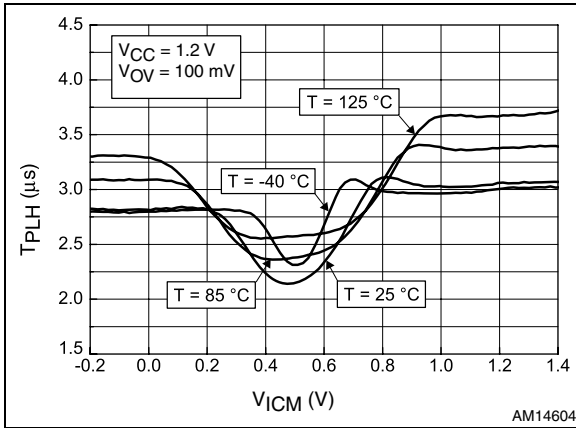


Figure 21. Propagation delay  $T_{PHL}$  vs. input common mode voltage at  $V_{CC} = 1.2\text{ V}$

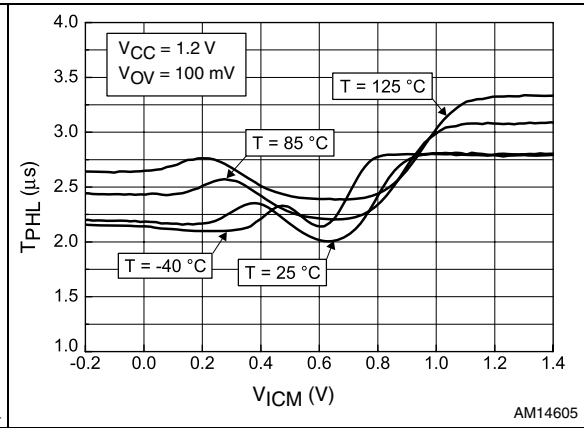


Figure 22. Propagation delay  $T_{PLH}$  vs. input common mode voltage at  $V_{CC} = 5\text{ V}$

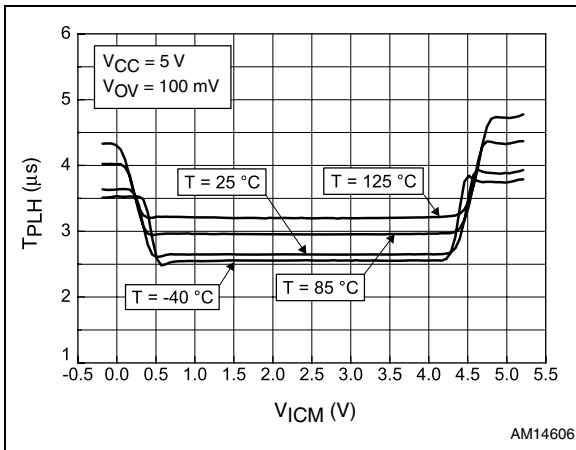


Figure 23. Propagation delay  $T_{PHL}$  vs. input common mode voltage at  $V_{CC} = 5\text{ V}$

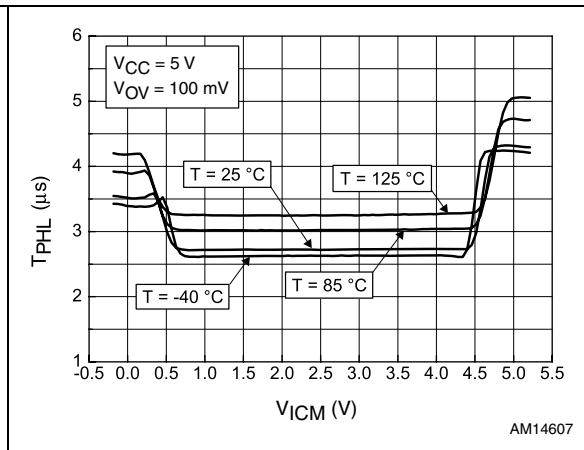


Figure 24. Propagation delay  $T_{PLH}$  vs. input signal overdrive at  $V_{CC} = 1.2\text{ V}$

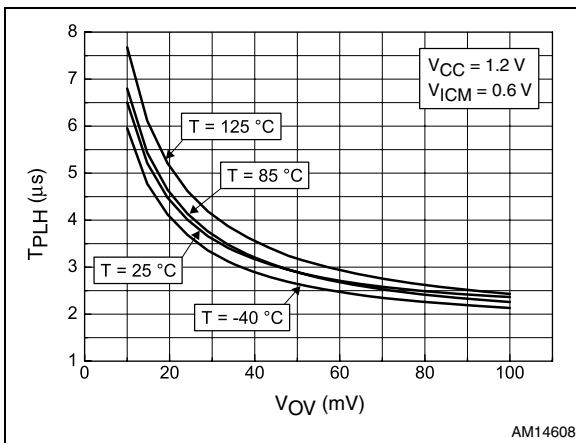


Figure 25. Propagation delay  $T_{PHL}$  vs. input signal overdrive at  $V_{CC} = 1.2\text{ V}$

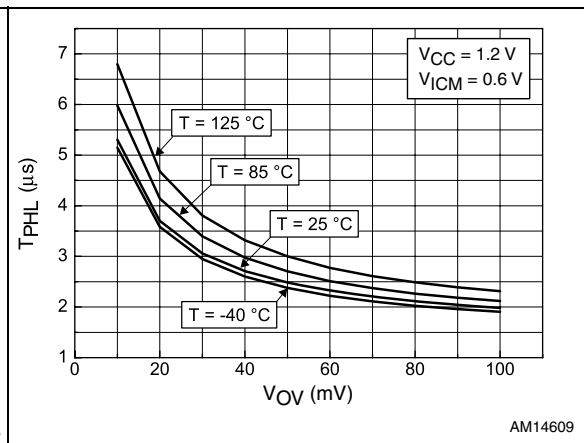


Figure 26. Propagation delay  $T_{PLH}$  vs. input signal overdrive at  $V_{CC} = 5\text{ V}$

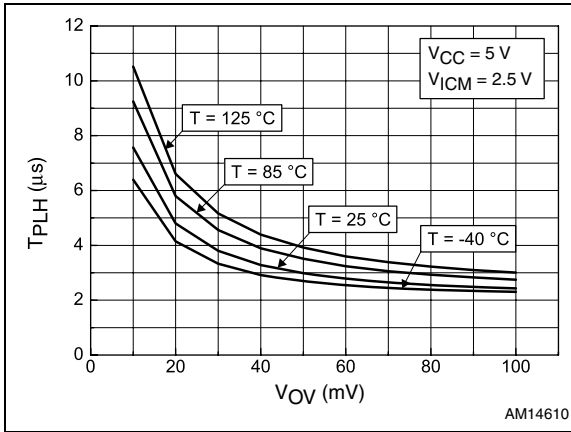


Figure 27. Propagation delay  $T_{PHL}$  vs. input signal overdrive at  $V_{CC} = 5\text{ V}$

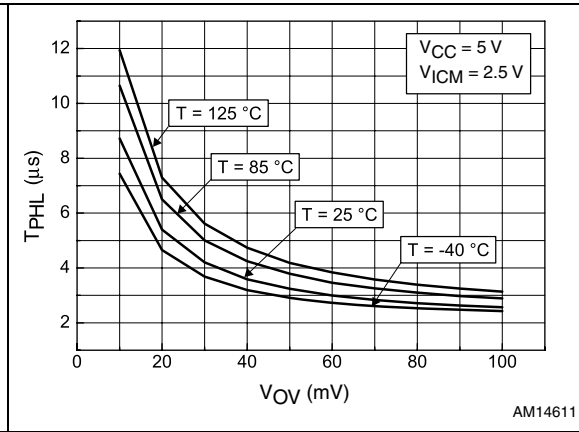


Figure 28. Propagation delay  $T_{PLH}$  vs. supply voltage for signal overdrive 10 mV

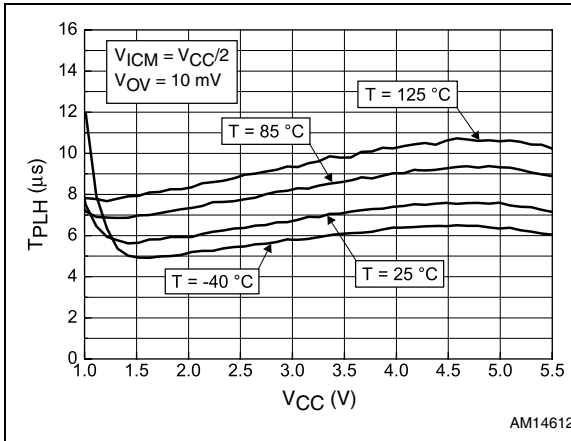


Figure 29. Propagation delay  $T_{PHL}$  vs. supply voltage for signal overdrive 10 mV

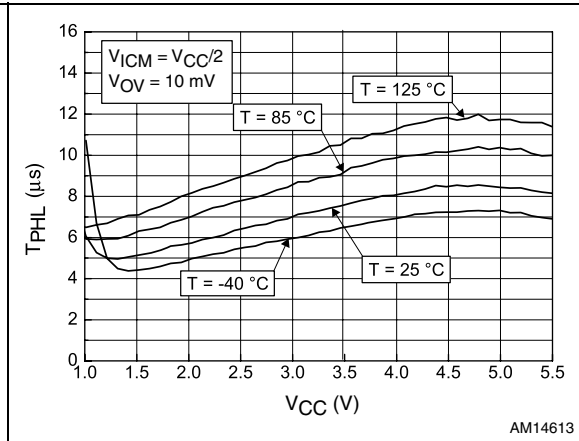


Figure 30. Propagation delay  $T_{PLH}$  vs. supply voltage for signal overdrive 100 mV

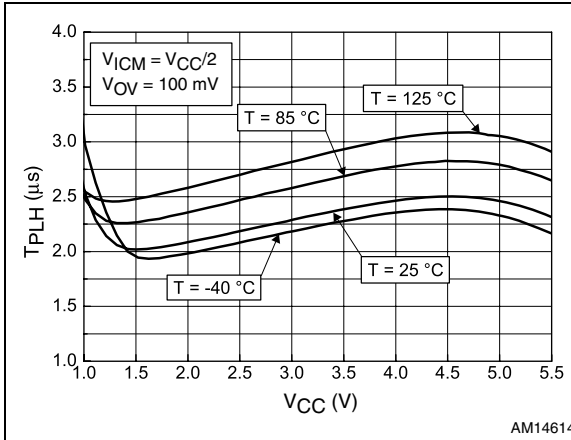


Figure 31. Propagation delay  $T_{PHL}$  vs. supply voltage for signal overdrive 100 mV

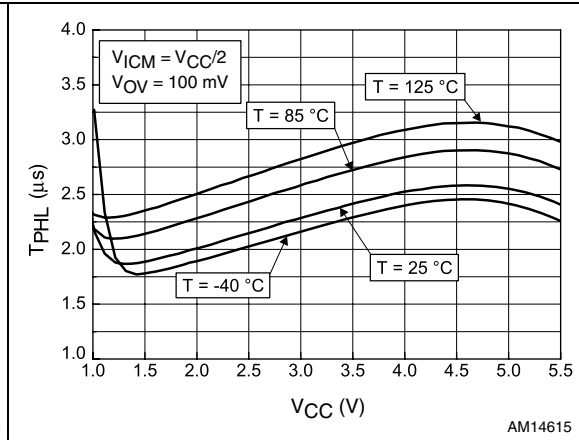


Figure 32. Propagation delay vs. temperature for signal overdrive 10 mV

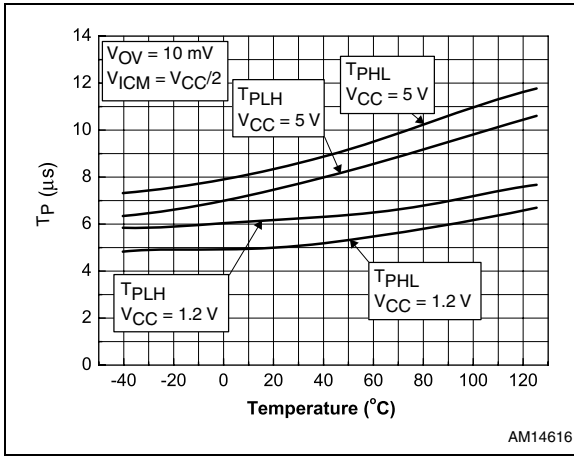
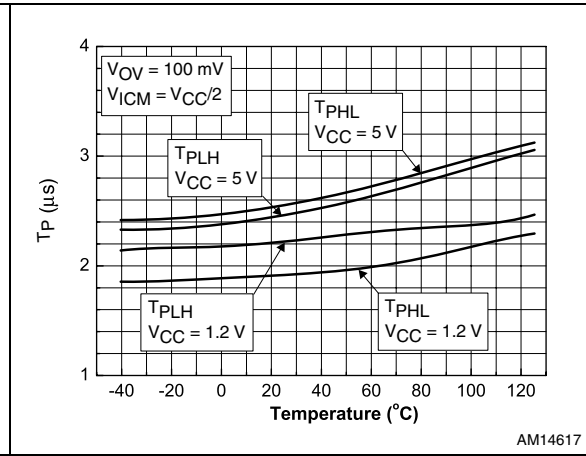


Figure 33. Propagation delay vs. temperature for signal overdrive 100 mV



### 3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

Figure 34. SC70-5 (SOT323-5) package outline

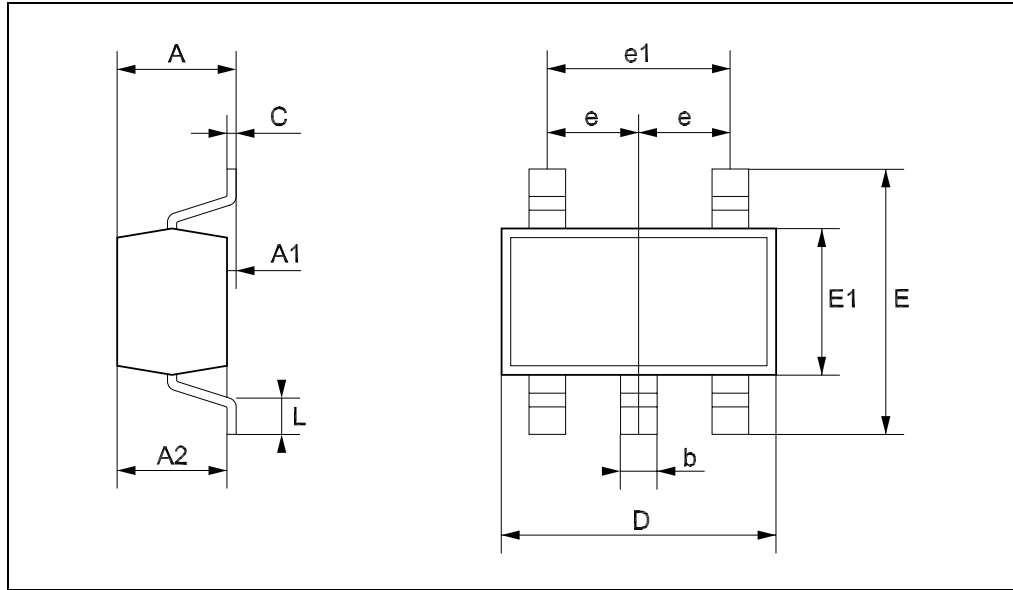


Table 6. SC70-5 (SOT323-5) package mechanical data

Symbol	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80		1.10	31.5		43.3
A1	0.00		0.10	0.0		3.9
A2	0.80	0.9	1.00	31.5	35.4	39.4
b	0.15		0.30	5.9		11.8
C	0.10		0.22	3.9		8.7
D	1.80		2.20	70.9		86.6
E	1.80		2.40	70.9		94.5
E1	1.15	1.25	1.35	45.3	49.2	53.1
e		0.65			25.6	
e1		1.3			51.2	
L	0.26	0.36	0.46	10.2	14.2	18.1

## 4 Ordering information

Table 7. Order codes

Order code	Temperature range	Package	Packaging	Marking
TS881ICT	-40 to +125 °C	SC70-5	Tape and reel	K56

## 5 Revision history

Table 8. Document revision history

Date	Revision	Changes
18-Jul-2012	1	Initial release.



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